## Fast IGBT in NPT-technology

- $75 \%$ lower $E_{\text {off }}$ compared to previous generation combined with low conduction losses
- Short circuit withstand time - $10 \mu \mathrm{~s}$
- Designed for:

- Motor controls
- Inverter
- NPT-Technology for 600V applications offers:
- very tight parameter distribution
- high ruggedness, temperature stable behaviour
- parallel switching capability
- Qualified according to JEDEC ${ }^{2}$ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/

| Type | $V_{\text {CE }}$ | $I_{\mathrm{C}}$ | $V_{\mathrm{CE}\left(\text { sat) } 150^{\circ} \mathrm{C}\right.}$ | $\boldsymbol{T}_{\mathrm{j}}$ | Marking | Package |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| SGB02N60 | 600 V | 2 A | 2.2 V | $150^{\circ} \mathrm{C}$ | G02N60 | PG-TO-263-3-2 |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-emitter voltage | $V_{\text {CE }}$ | 600 | V |
| DC collector current $\begin{aligned} & T_{\mathrm{C}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{C}}=100^{\circ} \mathrm{C} \end{aligned}$ | $I_{C}$ | $\begin{aligned} & 6.0 \\ & 2.9 \end{aligned}$ | A |
| Pulsed collector current, $t_{\mathrm{p}}$ limited by $T_{\text {jmax }}$ | $I_{\text {Cpuls }}$ | 12 |  |
| Turn off safe operating area $V_{\mathrm{CE}} \leq 600 \mathrm{~V}, T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}$ | - | 12 |  |
| Gate-emitter voltage | $V_{\text {GE }}$ | $\pm 20$ | V |
| Avalanche energy, single pulse $\begin{aligned} & I_{\mathrm{C}}=2 \mathrm{~A}, V_{\mathrm{CC}}=50 \mathrm{~V}, R_{\mathrm{GE}}=25 \Omega, \\ & \text { start at } T_{\mathrm{j}}=25^{\circ} \mathrm{C} \end{aligned}$ | $E_{\text {AS }}$ | 13 | mJ |
| Short circuit withstand time ${ }^{1)}$ $V_{\mathrm{GE}}=15 \mathrm{~V}, V_{\mathrm{CC}} \leq 600 \mathrm{~V}, T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}$ | $t_{\text {Sc }}$ | 10 | $\mu \mathrm{s}$ |
| Power dissipation $T_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $P_{\text {tot }}$ | 30 | W |
| Operating junction and storage temperature | $T_{\mathrm{j}}, T_{\text {stg }}$ | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| Soldering temperature (reflow soldering, MSL1) |  | 245 |  |

[^0]Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Characteristic |  |  |  |  |
| IGBT thermal resistance, junction - case | $R_{\text {thJc }}$ |  | 4.2 | K/W |
| Thermal resistance, junction - ambient ${ }^{1)}$ | $R_{\text {thJA }}$ |  | 40 |  |

Electrical Characteristic, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value |  |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Typ. | max. |  |  |

## Static Characteristic

| Collector-emitter breakdown voltage | $V_{\text {(BR)CES }}$ | $V_{\mathrm{GE}}=0 \mathrm{~V}, I_{\mathrm{C}}=500 \mu \mathrm{~A}$ | 600 | - | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Collector-emitter saturation voltage | $V_{\text {CE(sat) }}$ | $\begin{aligned} & V_{G E}=15 \mathrm{~V}, I_{\mathrm{C}}=2 \mathrm{~A} \\ & T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | 1.7 | $\begin{aligned} & 1.9 \\ & 2.2 \end{aligned}$ | $\begin{aligned} & 2.4 \\ & 2.7 \end{aligned}$ |  |
| Gate-emitter threshold voltage | $V_{\text {GE(th) }}$ | $I_{C}=150 \mu \mathrm{~A}, V_{\mathrm{CE}}=V_{\mathrm{GE}}$ | 3 | 4 | 5 |  |
| Zero gate voltage collector current | $I_{\text {CES }}$ | $\begin{aligned} & V_{\mathrm{CE}}=600 \mathrm{~V}, V_{\mathrm{GE}}=0 \mathrm{~V} \\ & T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ |  | - | $\begin{gathered} 20 \\ 250 \end{gathered}$ | $\mu \mathrm{A}$ |
| Gate-emitter leakage current | $I_{\text {GES }}$ | $V_{\text {CE }}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=20 \mathrm{~V}$ | - | - | 100 | nA |
| Transconductance | $g_{\text {fs }}$ | $V_{C E}=20 \mathrm{~V}, I_{C}=2 \mathrm{~A}$ | - | 1.6 | - | S |

Dynamic Characteristic

| Input capacitance | $C_{\text {iss }}$ | $\begin{aligned} & V_{\mathrm{CE}}=25 \mathrm{~V}, \\ & V_{\mathrm{GE}}=0 \mathrm{~V}, \\ & f=1 \mathrm{MHz} \end{aligned}$ | - | 142 | 170 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output capacitance | $C_{\text {oss }}$ |  | - | 18 | 22 |  |
| Reverse transfer capacitance | $C_{\text {rss }}$ |  | - | 10 | 12 |  |
| Gate charge | $Q_{\text {Gate }}$ | $\begin{aligned} & V_{\mathrm{CC}}=480 \mathrm{~V}, I_{\mathrm{C}}=2 \mathrm{~A} \\ & V_{\mathrm{GE}}=15 \mathrm{~V} \end{aligned}$ | - | 14 | 18 | nC |
| Internal emitter inductance measured 5 mm (0.197 in.) from case | $L_{E}$ |  | - | 7 | - | nH |
| Short circuit collector current ${ }^{2)}$ | $I_{\text {C(SC) }}$ | $\begin{aligned} & V_{\mathrm{GE}}=15 \mathrm{~V}, t_{\mathrm{SC}} \leq 10 \mu \mathrm{~s} \\ & V_{\mathrm{CC}} \leq 600 \mathrm{~V} \\ & T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C} \end{aligned}$ | - | 20 | - | A |

[^1]Switching Characteristic, Inductive Load, at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$

| Parameter | Symbol | Conditions | Value |  |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | typ. | max. |  |

IGBT Characteristic

| Turn-on delay time | $t_{\mathrm{d} \text { (on) }}$ | $\begin{aligned} & T_{\mathrm{j}}=25^{\circ} \mathrm{C}, \\ & \mathrm{~V}_{\mathrm{CC}}=400 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=2 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GE}}=0 / 15 \mathrm{~V}, \\ & R_{\mathrm{G}}=118 \Omega, \\ & L_{\sigma^{11}}=180 \mathrm{nH}, \\ & C_{\sigma}{ }^{1 \prime}=180 \mathrm{pF} . \end{aligned}$ <br> Energy losses include "tail" and diode reverse recovery. | - | 20 | 24 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Rise time | $t_{\mathrm{r}}$ |  | - | 13 | 16 |  |
| Turn-off delay time | $t_{\mathrm{d} \text { (off) }}$ |  | - | 259 | 311 |  |
| Fall time | $t_{f}$ |  | - | 52 | 62 |  |
| Turn-on energy | $E_{\text {on }}$ |  | - | 0.036 | 0.041 | mJ |
| Turn-off energy | $E_{\text {off }}$ |  | - | 0.028 | 0.036 |  |
| Total switching energy | $E_{\text {ts }}$ |  | - | 0.064 | 0.078 |  |

Switching Characteristic, Inductive Load, at $T_{\mathrm{j}}=150^{\circ} \mathrm{C}$

| Parameter | Symbol | Conditions | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | min. | typ. | max. |  |
| IGBT Characteristic |  |  |  |  |  |  |
| Turn-on delay time | $t_{\text {d }(\text { on) }}$ | $\begin{aligned} & T_{\mathrm{j}}=150^{\circ} \mathrm{C}, \\ & \mathrm{~V}_{\mathrm{CC}}=400 \mathrm{~V}, I_{\mathrm{C}}=2 \mathrm{~A}, \\ & V_{\mathrm{GE}}=0 / 15 \mathrm{~V}, \\ & R_{\mathrm{G}}=118 \Omega, \\ & L_{\sigma^{1}}{ }^{1 \prime}=180 \mathrm{nH}, \\ & \underline{C}_{\sigma}{ }^{1}=180 \mathrm{pF} \end{aligned}$ <br> Energy losses include "tail" and diode reverse recovery. | - | 20 | 24 | ns |
| Rise time | $t_{\mathrm{r}}$ |  | - | 14 | 17 |  |
| Turn-off delay time | $t_{\text {d (off) }}$ |  | - | 287 | 344 |  |
| Fall time | $t_{\text {f }}$ |  | - | 67 | 80 |  |
| Turn-on energy | $E_{\text {on }}$ |  | - | 0.054 | 0.062 | mJ |
| Turn-off energy | $E_{\text {off }}$ |  | - | 0.043 | 0.056 |  |
| Total switching energy | $E_{\text {ts }}$ |  | - | 0.097 | 0.118 |  |

${ }^{1)}$ Leakage inductance $L_{\sigma}$ and Stray capacity $C_{\sigma}$ due to dynamic test circuit in Figure $E$.


Figure 1. Collector current as a function of switching frequency
( $T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}, D=0.5, V_{\mathrm{CE}}=400 \mathrm{~V}$, $\left.V_{G E}=0 /+15 \mathrm{~V}, R_{\mathrm{G}}=118 \Omega\right)$

$T_{\mathrm{C}}$, CASE TEMPERATURE
Figure 3. Power dissipation (IGBT) as a function of case temperature
( $T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}$ )

$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 2. Safe operating area
( $D=0, T_{\mathrm{C}}=25^{\circ} \mathrm{C}, T_{\mathrm{j}} \leq 150^{\circ} \mathrm{C}$ )

$T_{\mathrm{C}}$, CASE TEMPERATURE
Figure 4. Collector current as a function of case temperature
$\left(V_{G E} \leq 15 \mathrm{~V}, T_{j} \leq 150^{\circ} \mathrm{C}\right)$

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$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 5. Typical output characteristics ( $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ )

$V_{\text {GE }}$, GATE-EMITTER VOLTAGE
Figure 7. Typical transfer characteristics ( $V_{C E}=10 \mathrm{~V}$ )

$V_{\text {CE }}$, COLLECTOR-EMITTER VOLTAGE
Figure 6. Typical output characteristics
( $T_{\mathrm{j}}=150^{\circ} \mathrm{C}$ )

$T_{\mathrm{j}}$, JUNCTION TEMPERATURE
Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature
$\left(V_{\mathrm{GE}}=15 \mathrm{~V}\right)$


Figure 9. Typical switching times as a function of collector current
(inductive load, $T_{\mathrm{j}}=150^{\circ} \mathrm{C}, V_{\mathrm{CE}}=400 \mathrm{~V}$, $V_{\mathrm{GE}}=0 /+15 \mathrm{~V}, R_{\mathrm{G}}=118 \Omega$,
Dynamic test circuit in Figure E)


Figure 11. Typical switching times as a function of junction temperature
(inductive load, $V_{C E}=400 \mathrm{~V}, V_{G E}=0 /+15 \mathrm{~V}$, $I_{\mathrm{C}}=2 \mathrm{~A}, R_{\mathrm{G}}=118 \Omega$,
Dynamic test circuit in Figure E)
$t$, SWITCHING TIMES


Figure 10. Typical switching times as a function of gate resistor
(inductive load, $T_{\mathrm{j}}=150^{\circ} \mathrm{C}, V_{\mathrm{CE}}=400 \mathrm{~V}$, $V_{G E}=0 /+15 \mathrm{~V}, I_{C}=2 \mathrm{~A}$,
Dynamic test circuit in Figure E)


Figure 12. Gate-emitter threshold voltage as a function of junction temperature ( $I_{C}=0.15 \mathrm{~mA}$ )


Figure 13. Typical switching energy losses as a function of collector current
(inductive load, $T_{j}=150^{\circ} \mathrm{C}, V_{C E}=400 \mathrm{~V}$, $V_{\mathrm{GE}}=0 /+15 \mathrm{~V}, R_{\mathrm{G}}=118 \Omega$,
Dynamic test circuit in Figure E)


Figure 15. Typical switching energy losses as a function of junction temperature (inductive load, $V_{C E}=400 \mathrm{~V}, V_{G E}=0 /+15 \mathrm{~V}$, $I_{C}=2 \mathrm{~A}, R_{\mathrm{G}}=118 \Omega$,
Dynamic test circuit in Figure E)


Figure 14. Typical switching energy losses as a function of gate resistor
(inductive load, $T_{j}=150^{\circ} \mathrm{C}, V_{\mathrm{CE}}=400 \mathrm{~V}$, $V_{\mathrm{GE}}=0 /+15 \mathrm{~V}, I_{\mathrm{C}}=2 \mathrm{~A}$,
Dynamic test circuit in Figure E)


Figure 16. IGBT transient thermal impedance as a function of pulse width ( $D=t_{\mathrm{p}} / T$ )


Figure 17. Typical gate charge
$\left(I_{C}=2 A\right)$


Figure 19. Short circuit withstand time as a function of gate-emitter voltage
( $V_{\text {CE }}=600 \mathrm{~V}$, start at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$ )


Figure 18. Typical capacitance as a function of collector-emitter voltage ( $V_{G E}=0 \mathrm{~V}, f=1 \mathrm{MHz}$ )


Figure 20. Typical short circuit collector current as a function of gate-emitter voltage
$\left(V_{\text {CE }} \leq 600 \mathrm{~V}, T_{\mathrm{j}}=150^{\circ} \mathrm{C}\right)$

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Figure A. Definition of switching times


Figure B. Definition of switching losses


Figure D. Thermal equivalent circuit


Figure E. Dynamic test circuit Leakage inductance $L_{\sigma}=180 \mathrm{nH}$ and Stray capacity $C_{\sigma}=180 \mathrm{pF}$.

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FGH75T65UPD STGWA15H120F2 IKA10N60TXKSA1 IHW20N120R5XKSA1 RJH60D2DPP-M0\#T2 IKP20N60TXKSA1 IHW20N65R5XKSA1 IDW40E65D2FKSA1


[^0]:    ${ }^{2}$ J-STD-020 and JESD-022
    ${ }^{1)}$ Allowed number of short circuits: <1000; time between short circuits: $>1 \mathrm{~s}$.

[^1]:    ${ }^{1)}$ Device on $50 \mathrm{~mm} * 50 \mathrm{~mm} * 1.5 \mathrm{~mm}$ epoxy PCB FR4 with $6 \mathrm{~cm}^{2}$ (one layer, $70 \mu \mathrm{~m}$ thick) copper area for collector connection. PCB is vertical without blown air.
    ${ }^{2)}$ Allowed number of short circuits: <1000; time between short circuits: $>1 \mathrm{~s}$.

